

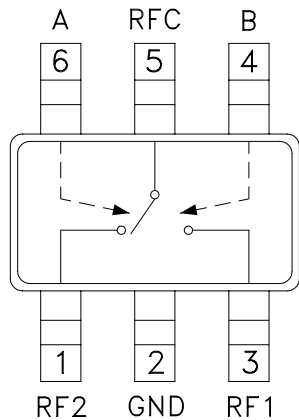


### Typical Applications

The HMC545A / HMC545AE is ideal for:

- Cellular/3G Infrastructure
- Private Mobile Radio Handsets
- WLAN, WiMAX & WiBro
- Automotive Telematics
- Test Equipment

### Functional Diagram



### Features

- Low Insertion Loss: 0.27 dB
- High Input IP3: +54 dBm
- Low DC Power Consumption
- Positive Control: 0/+3V to 0/+8V
- Ultra Small Package: SOT26

### General Description

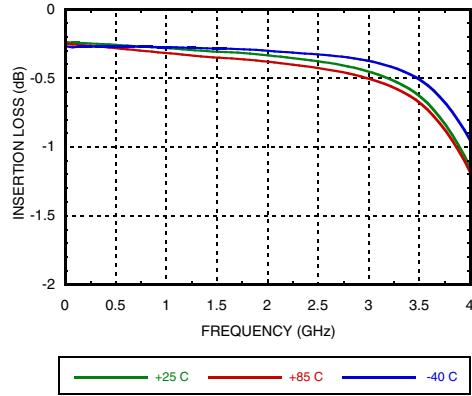
The HMC545A and HMC545AE are low-cost SPDT switches in 6-lead SOT26 plastic packages for use in general switching applications which require very low insertion loss and very small size. With 0.25 dB typical loss, these devices can control signals from DC to 3.0 GHz and are especially suited for IF and RF applications including Cellular/3G, ISM, automotive and portables. The design provides exceptional insertion loss performance, ideal for filter and receiver switching. RF1 and RF2 are reflective shorts when "Off". The two control voltages require a minimal amount of DC current and offer compatibility with CMOS and some TTL logic families.

### Electrical Specifications

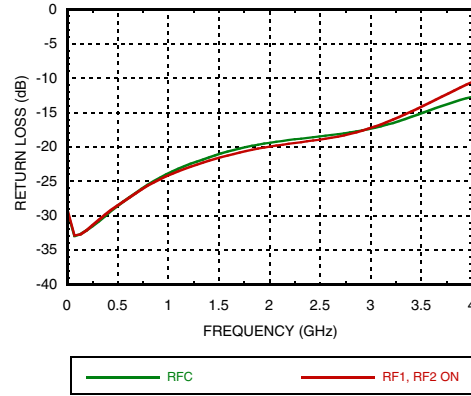
$T_A = +25^\circ\text{C}$ ,  $V_{ctl} = 0/+5\text{Vdc}$  (Unless Otherwise Stated), 50 Ohm System

Parameter	Frequency	Min.	Typ.	Max.	Units
Insertion Loss	DC - 1.0 GHz		0.27	0.4	dB
	DC - 2.5 GHz		0.3	0.5	dB
	DC - 3.0 GHz		0.4	0.7	dB
Isolation	DC - 2.0 GHz	26	31		dB
	DC - 2.5 GHz	22	26		dB
	DC - 3.0 GHz	19	22		dB
Return Loss	DC - 1.0 GHz		24		dB
	DC - 2.0 GHz		20		dB
	DC - 2.5 GHz		19		dB
	DC - 3.0 GHz		17		dB
Input Power for 1 dB Compression	$V_{ctl} = 0/+3\text{V}$	20	23		dBm
	$V_{ctl} = 0/+5\text{V}$	27	30		dBm
	$V_{ctl} = 0/+8\text{V}$	30	33		dBm
Input Third Order Intercept (Two-tone Input Power = +17 dBm Each Tone)	$V_{ctl} = 0/+3\text{V}$		31		dBm
	$V_{ctl} = 0/+5\text{V}$		51		dBm
	$V_{ctl} = 0/+8\text{V}$		54		dBm
Switching Characteristics	DC - 3.0 GHz				
		tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)		70 90	ns ns

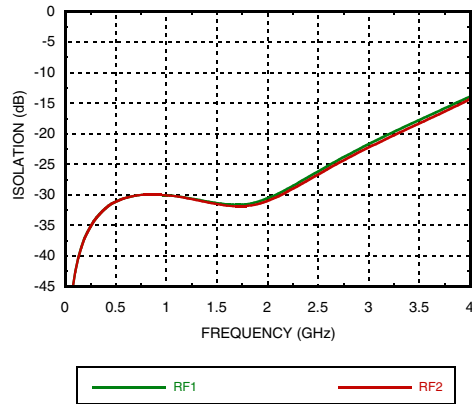
### Insertion Loss



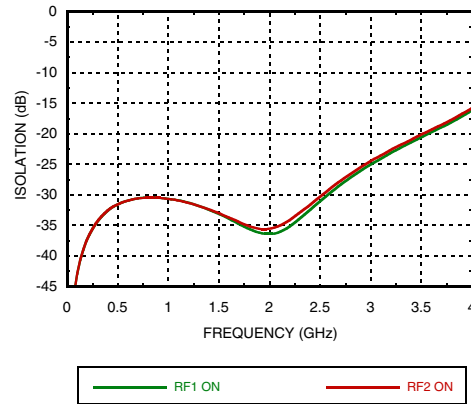
### Return Loss



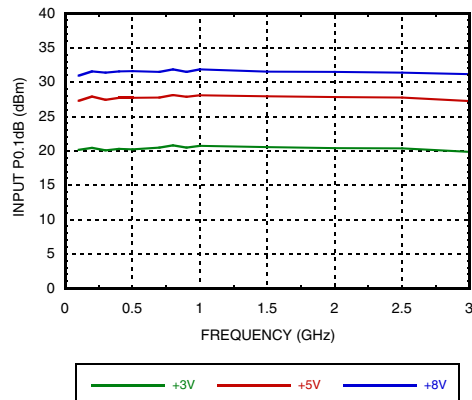
### Isolation Between Ports RFC and RF1/RF2



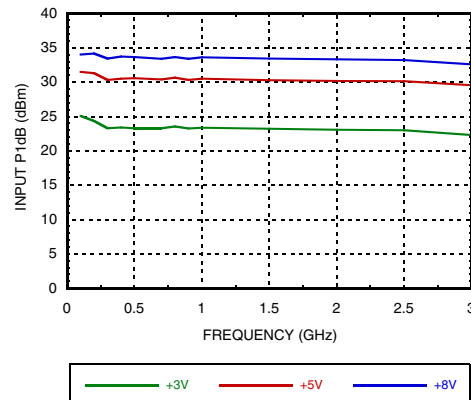
### Isolation Between Ports RF1 and RF2



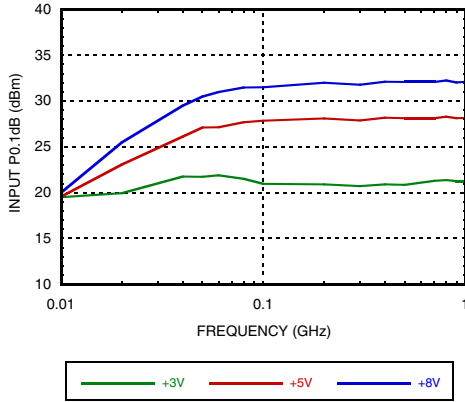
### Input P0.1dB vs. Vctl



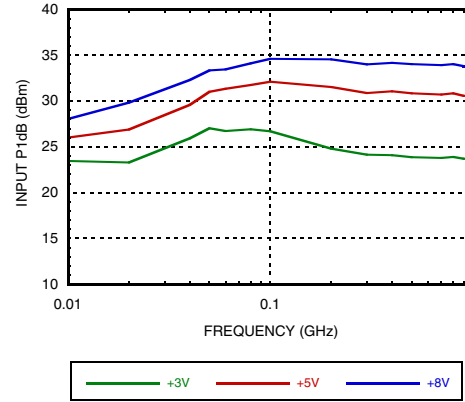
### Input P1dB vs. Vctl



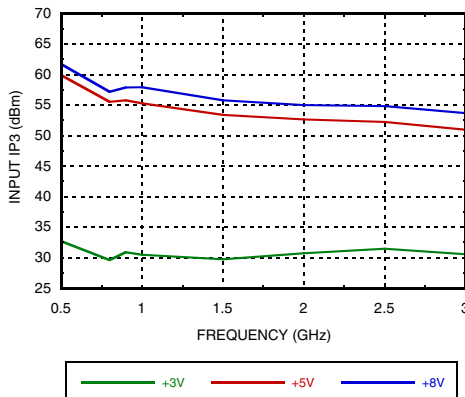
### Low Frequency Input P0.1dB vs. Vctl



### Low Frequency Input P1dB vs. Vctl



### Input Third Order Intercept Point vs. Control Voltage



### Absolute Maximum Ratings

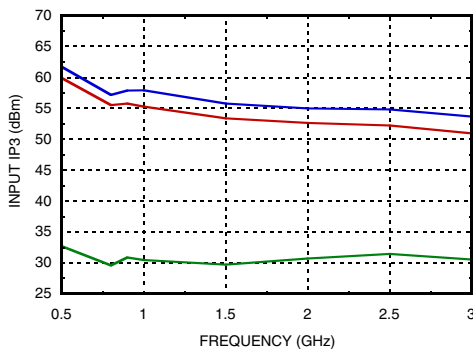
RF Input Power (Vctl = 0/+8V)	+34 dBm
Control Voltage Range (A & B)	-0.2 to +12 Vdc
Hot Switch Power Level (Vctl = 0/+8V)	+32 dBm
Channel Temperature	150 °C
Continuous P <sub>diss</sub> (T = 85 °C) (derate 5.6 mW/ °C above 85 °C)	0.1 W
Thermal Resistance	169 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

DC blocks are required at ports RFC, RF1 and RF2.



**ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS**

### Insertion Loss, T = +25 °C



### Truth Table

Control Input		Control Current	
A	B	RFC to RF1	RFC to RF2
Low	High	Off	On
High	Low	On	Off

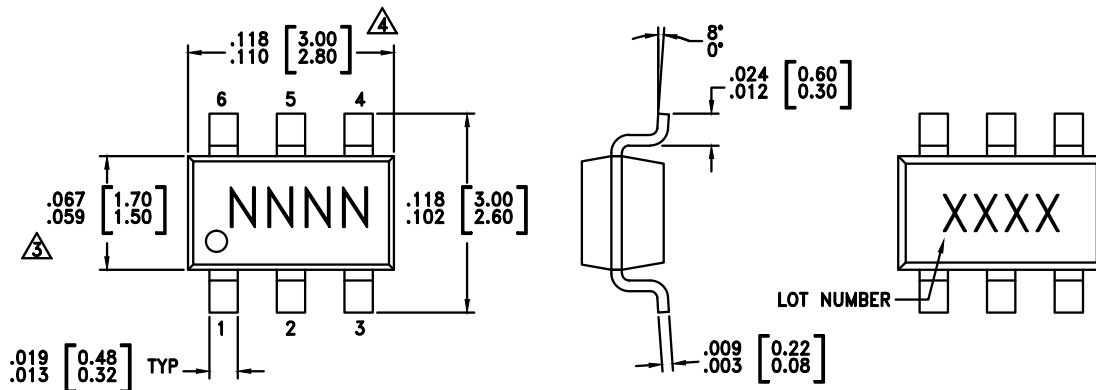
### Control Voltages

State	Bias Condition
Low	0 to 0.2 Vdc @ 1 μA Typical
High	+3 Vdc @ 0.5 μA Typical to +8 Vdc @ 14 μA Typical (±0.2 Vdc)



## GaAs MMIC SPDT SWITCH, DC - 3 GHz

### Outline Drawing



- NOTES:
- LEADFRAME MATERIAL: COPPER ALLOY
  - DIMENSIONS ARE IN INCHES [MILLIMETERS].
  - DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
  - DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
  - ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

### Package Information

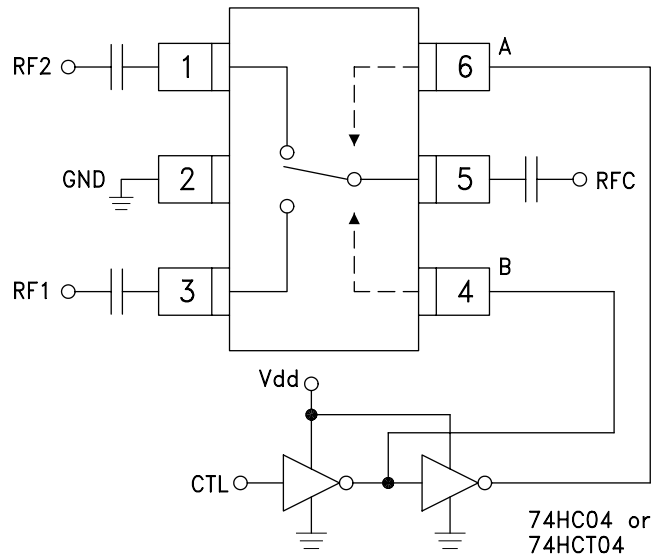
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking
HMC545A	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H545A
HMC545AE	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	545AE

[1] Max peak reflow temperature of 235 °C  
 [2] Max peak reflow temperature of 260 °C



## GaAs MMIC SPDT SWITCH, DC - 3 GHz

### Typical Application Circuit



#### Notes:

1. Set logic gate Vdd = +3V to +5V and use HCT series logic to provide a TTL driver interface.
2. Control inputs A/B can be driven directly with CMOS logic (HC) with Vdd of +3V to +8V applied to the CMOS logic gates.
3. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.
4. Highest RF signal power capability is achieved with Vdd = +8V and A/B set to 0/+8V.

### Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 5	RF2, RF1, RFC	These pins are DC coupled and matched to 50 Ohms. Blocking capacitors are required.	
2	GND	This pin must be connected to RF/DC ground.	
4	B	See truth and control voltage tables.	
6	A	See truth and control voltage tables.	